### FAIRCHILD

SEMICONDUCTOR®

# FDD8770/FDU8770 N-Channel PowerTrench<sup>®</sup> MOSFET 25V, 35A, 4.0m $\Omega$

### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$  and fast switching speed.

### Features

- Max  $r_{DS(on)}$  = 4.0m $\Omega$  at V<sub>GS</sub> = 10V, I<sub>D</sub> = 35A
- Max  $r_{DS(on)}$  = 5.5m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 35A
- Low gate charge: Q<sub>g(10)</sub> = 52nC(Typ), V<sub>GS</sub> = 10V

GC

- Low gate resistance
- RoHS Compliant

### Application

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture

### S D-PAK G D S I-PAK S (TO-252) (TO-251AA) Short Lead I-PAK

#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		25	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
	Drain Current -Continuous (Package Limited)		35	
I <sub>D</sub>	-Continuous (Die Limited)		210	Α
	-Pulsed	(Note 1)	407	
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	113	mJ
P <sub>D</sub>	Power Dissipation		115	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 175	°C
Therma	Characteristics			
$R_{\theta JC}$	Thermal Resistance, Junction to Case TO-252, TO-251		1.3	°C/W
-				

, (A)C		1.0	0/11
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient TO-252, TO-251	100	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient TO-252,1in <sup>2</sup> copper pad area	52	°C/W

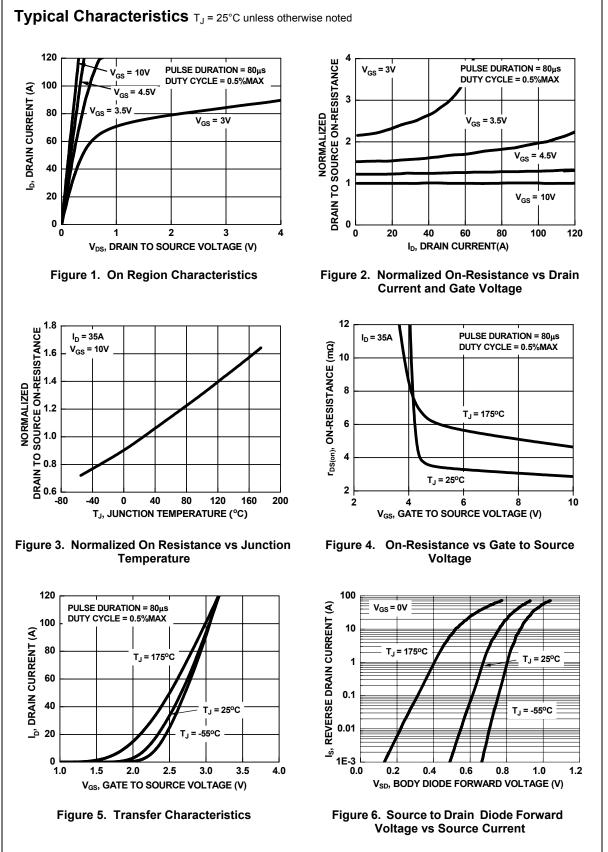
### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8770	FDD8770	TO-252AA	13"	12mm	2500 units
FDU8770	FDU8770	TO-251AA	N/A(Tube)	N/A	75 units
FDU8770	FDU8770_F071	TO-251AA	N/A(Tube)	N/A	75 units

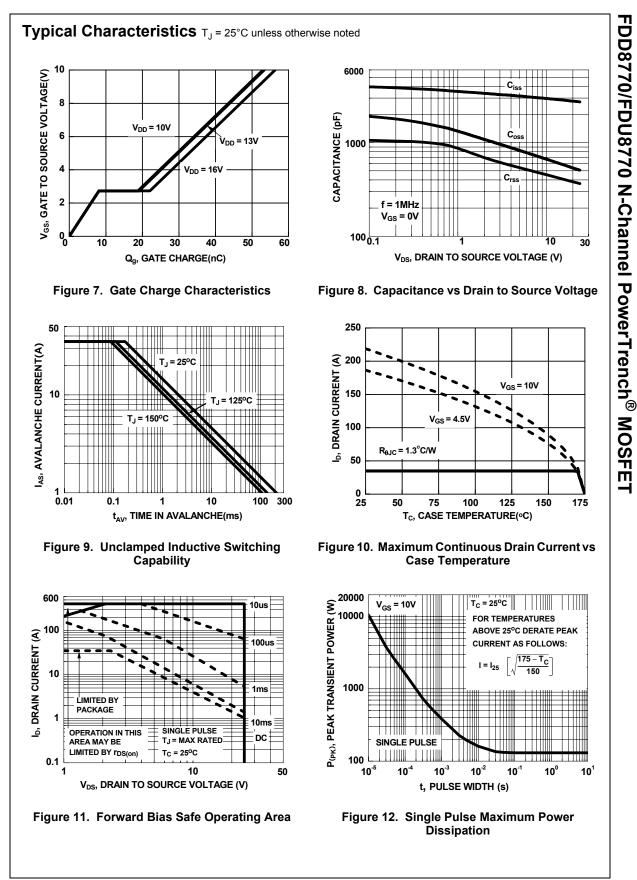
#### March 2006

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Chara	acteristics						
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		25			V
ΔB <sub>VDSS</sub>	Breakdown Voltage Temperature	$I_D = 250 \mu A$ , referenced to			13.6		mV/°C
$\Delta T_J$	Coefficient	25°C			13.0		mv/°C
<b> </b>		V <sub>DS</sub> = 20V,				1	μA
IDSS	$V_{\rm GS} = 0V$		50°C			250	μ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V$				±100	nA
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	A	1.2	1.6	2.5	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_D = 250 \mu A$ , referenced			5.0		mV/°C
$\Delta T_J$	Temperature Coefficient	25°C			-5.9		
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A			3.3	4.0	-
(DC(an)	Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 35A			4.0	5.5	mΩ
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A			4.8	5.9	11152
		T <sub>J</sub> = 175°C					
		5					
-	Characteristics				1	1	
C <sub>iss</sub>	Characteristics Input Capacitance				2795	3720	pF
C <sub>iss</sub> C <sub>oss</sub>	Input Capacitance Output Capacitance	V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, f = 1MHz			2795 685	3720 915	pF pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	- V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, f = 1MHz			685 450		
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance	V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V,			685	915	pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	- V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, f = 1MHz			685 450	915	pF pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub> Switchinç	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	- V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, f = 1MHz f = 1MHz			685 450	915	pF pF
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$			685 450 1.5	915 675	pF pF Ω
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> Rg Switching t <sub>d(on)</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>g Characteristics</b> Turn-On Delay Time	- V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, f = 1MHz f = 1MHz			685 450 1.5 10	915 675 20	pF pF Ω ns
$C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ <b>Switching</b> $t_{d(on)}$ $t_r$ $t_{d(off)}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$			685 450 1.5 10 12	915 675 20 22	pF pF Ω ns
$C_{iss}$ $C_{oss}$ $C_{rss}$ <b>Switching</b> $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V to 10V$			685 450 1.5 10 12 49	915 675 20 22 78	pF pF Ω ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ \hline \\ C_{rss} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ \hline \\ t_{r} \\ \hline \\ t_{r} \\ \hline \\ t_{d(off)} \\ \hline \\ t_{f} \\ \hline \\ Q_{g} \\ \hline \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance <b>g Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time	$V_{DS} = 13V, V_{GS} = 0V,$ $f = 1MHz$ $f = 1MHz$ $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 10V, T_{D} = 100$			685 450 1.5 10 12 49 25	915 675 20 22 78 40	pF pF Ω ns ns ns
$C_{iss}$ $C_{oss}$ $C_{rss}$ $R_g$ <b>Switching</b> $t_{d(on)}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance <b>g Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 3D$	35A -		685 450 1.5 10 12 49 25 52	915 675 20 22 78 40 73	pF pF Ω ns ns ns ns nc
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \hline \\ Q_g \\ \hline \\ Q_g \\ \hline \\ Q_g \\ \hline \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance <b>g Characteristics</b> Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{DS} = 13V, V_{GS} = 0V,$ $f = 1MHz$ $f = 1MHz$ $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 10V, T_{D} = 100$	35A -		685 450 1.5 10 12 49 25 52 29	915 675 20 22 78 40 73	pF pF Ω ns ns ns nc nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \hline \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller"Charge	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 3D$	35A -		685 450 1.5 10 12 49 25 52 29 8.1	915 675 20 22 78 40 73	pF pF Ω ns ns ns nC nC
$\begin{array}{c} \overline{C}_{iss} \\ \overline{C}_{oss} \\ \overline{C}_{rss} \\ \overline{R}_{g} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ \hline \\ \textbf{t}_{r} \\ \hline \\ \textbf{t}_{d(off)} \\ \hline \\ \textbf{t}_{f} \\ \hline \\ \hline \\ \textbf{Q}_{g} \\ \hline \\ \hline \\ \textbf{Q}_{g} \\ \hline \\ \textbf{Q}_{gs} \\ \hline \\ \textbf{Q}_{gd} \\ \hline \\ \hline \\ \textbf{Drain-Sol} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>Characteristics</b> Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller"Charge	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$ $I_D = 3I_g = 1$	35A -		685 450 1.5 10 12 49 25 52 29 8.1 11	915 675 20 22 78 40 73 41	pF pF Ω ns ns ns nc nC nC nC
$\begin{array}{c} \overline{C}_{iss} \\ \overline{C}_{oss} \\ \overline{C}_{rss} \\ \overline{R}_{g} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ \hline \\ \textbf{t}_{r} \\ \hline \\ \textbf{t}_{d(off)} \\ \hline \\ \textbf{t}_{f} \\ \hline \\ \hline \\ \textbf{Q}_{g} \\ \hline \\ \hline \\ \textbf{Q}_{g} \\ \hline \\ \textbf{Q}_{gs} \\ \hline \\ \textbf{Q}_{gd} \\ \hline \\ \hline \\ \textbf{Drain-Sol} \\ \hline \end{array}$	Input Capacitance         Output Capacitance         Reverse Transfer Capacitance         Gate Resistance         g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller"Charge	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 3I_D = 3I_g = 1$ $V_{GS} = 0V, I_S = 35A$	35A -		685 450 1.5 10 12 49 25 52 29 8.1 11 0.84	915 675 20 22 78 40 73 41 1.25	pF pF Ω ns ns ns nC nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance <b>Characteristics</b> Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller"Charge	$V_{DS} = 13V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{DD} = 13V, I_D = 35A$ $V_{GS} = 10V, R_{GS} = 5\Omega$ $V_{GS} = 0V \text{ to } 10V$ $V_{GS} = 0V \text{ to } 5V$ $I_D = 3I_g = 1$	35A - .0mA _		685 450 1.5 10 12 49 25 52 29 8.1 11	915 675 20 22 78 40 73 41	pF pF Ω ns ns ns nc nC nC nC

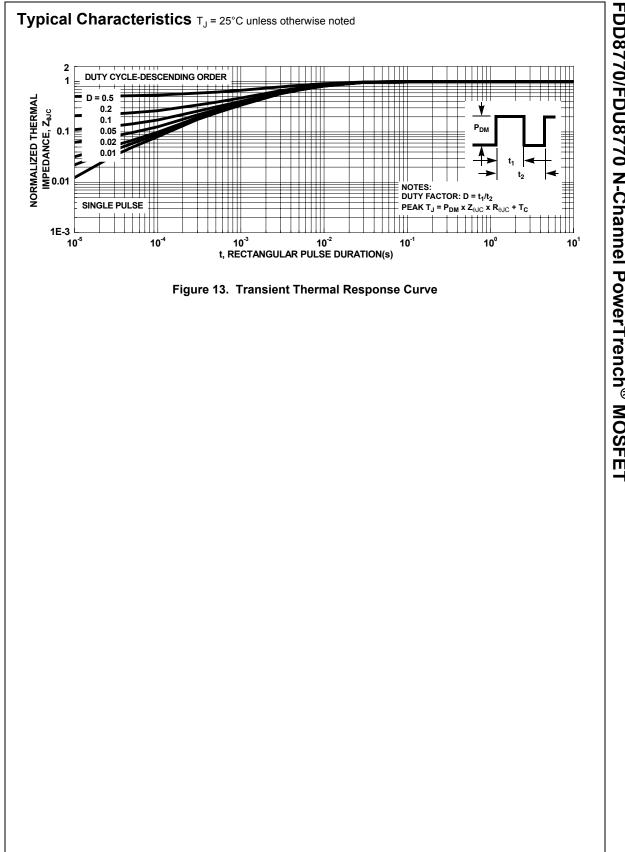
FDD8770/FDU8770 N-Channel PowerTrench<sup>®</sup> MOSFET



www.fairchildsemi.com



FDD8770/FDU8770 Rev. A



#### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™ FAST<sup>®</sup> ActiveArray™ FASTr™ Bottomless™ FPS™ Build it Now™ FRFET™ CoolFET™ GlobalOptoisolator™ CROSSVOLT™ GTO™ HiSeC™ DOME™ I<sup>2</sup>C™ **EcoSPARK™** E<sup>2</sup>CMOS™ i-Lo™ EnSigna™ ImpliedDisconnect<sup>™</sup> FACT™ IntelliMAX<sup>™</sup> FACT Quiet Series™ Across the board. Around the world.™ The Power Franchise<sup>®</sup> Programmable Active Droop™

**ISOPLANAR™** LittleFET™ MICROCOUPLER™ MicroFET™ MicroPak™ MICROWIRE™ MSX™ MSXPro™ OCX™ OCXPro™ OPTOLOGIC<sup>®</sup> OPTOPLANAR™ PACMAN™ POP™ Power247™

PowerEdge™ PowerSaver™ PowerTrench<sup>®</sup> QFET<sup>®</sup> QS™ QT Optoelectronics<sup>™</sup> Quiet Series™ RapidConfigure™ RapidConnect™ μSerDes™ ScalarPump™ SILENT SWITCHER<sup>®</sup> SMART START™ SPM™ Stealth™

SuperFET™ SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SyncFET™ тсм™ TinyLogic<sup>®</sup> TINYOPTO™ TruTranslation™ UHC™ UniFET™ UltraFET<sup>®</sup> VCX™ Wire™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor The datasheet is printed for reference information only.

## PRODUCT STATUS DEFINITIONS